



S1MSWFQ

1.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER

Product Summary (@T_A = +25°C)

Description and Applications

such as:

Notes:

Reverse Protection

Blocking

	V _{RRM} (V) I _O (A)		V _F Max (V)	I _R Max (μA)		
I	1,000	1	1.1	10		

The S1MSWFQ is a rectifier packaged in the SOD123F package.

Providing high reverse breakdown voltage and high current capability

for standard rectification, this device is ideal for use in applications

Features and Benefits

- Glass Passivated Die Construction
- Ideally Suited for Automated Assembly
- Small Form Factor, Low Profile
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

Mechanical Data

- Case: SOD123F
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.0016 grams (Approximate)

SOD123F



Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
S1MSWFQ-7	Automotive	SOD123F	3,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

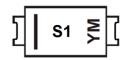
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and 1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



 $\begin{array}{l} S1 = \mbox{Product Type Marking Code} \\ YM = \mbox{Date Code Marking} \\ Y = \mbox{Year (ex.: C = 2015)} \\ M = \mbox{Month (ex: 9 = September)} \end{array}$

Date Code Key

Year		2015	2016	20	017	2018	201	9	2020	2021		2022
Code		С	D		E	F	G		Н			J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	1,000	v
RMS Reverse Voltage	V _{R(RMS)}	700	V
Average Rectified Output Current $@ T_A = +75^{\circ}C$	Ι _Ο	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	25	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 6)	R _{θJC}	13	°C/W
Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	78	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

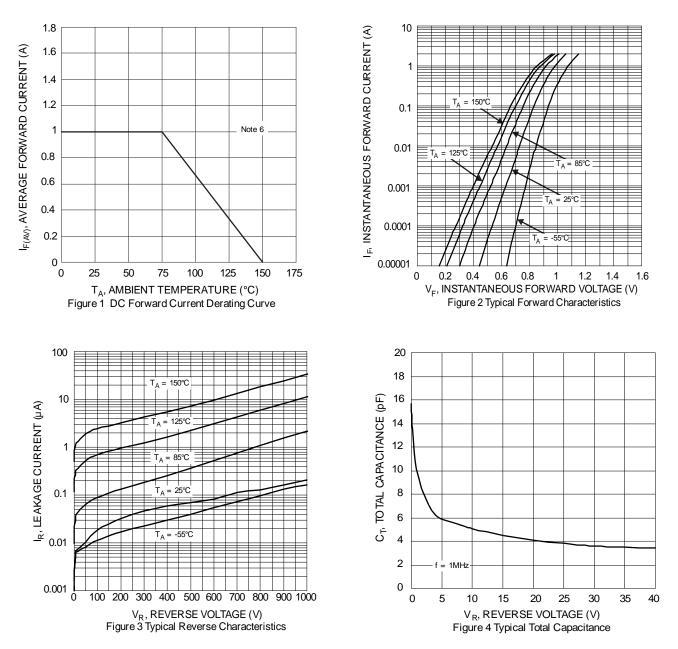
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symbol	Min	Тур	Max	Unit	Test Condition
V _{(BR)R}	1,000		—	V	I _R = 5μA
VF	—	0.98 0.88	1.1	V	I _F = 1A, T _J = +25°C I _F = 1A, T _J = +125°C
I _R	—	0.2 11	10 100	μA	$V_R = 1,000V, T_J = +25^{\circ}C$ $V_R = 1,000V, T_J = +125^{\circ}C$
t _{RR}	—	1.0	—	μs	I _F = 0.5A, I _R = 1.0A, I _{RR} = 0.25A
CT	_	6	_	pF	$V_R = 4.0V_{DC}$, f = 1MHz
	V _{(BR)R} VF I _R t _{RR}	V(BR)R 1,000 VF — IR — tRR —	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

6. Device mounted on FR4 PC board, 1 inch x 1 inch, 2oz. copper traces with 1x recommended pad layout, please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

7. Short duration pulse test used to minimize self-heating effect.

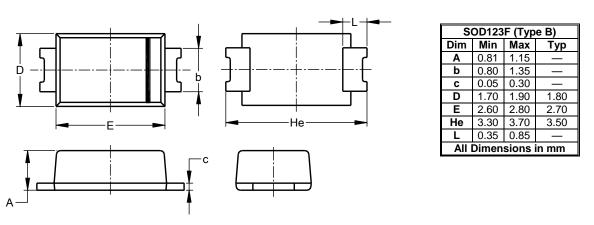






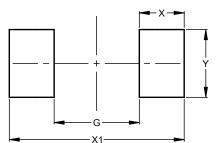
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



SOD123F (Type B)

Dimensions	Value (in mm)		
G	1.90		
Х	1.00		
X1	3.90		
Y	1.50		

SOD123F (Type B)



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